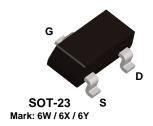


J174 J175 J176 **J177** **MMBFJ175** MMBFJ176 MMBFJ177





P-Channel Switch

This device is designed for low level analog switching sample and hold circuits and chopper stabilized amplifiers. Sourced from Process 88.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{DG}	Drain-Gate Voltage	- 30	V	
V_{GS}	Gate-Source Voltage	30	V	
I _{GF}	Forward Gate Current	50	mA	
T _J ,T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		J174 - J177	*MMBFJ175	
P_{D}	Total Device Dissipation	350	225	mW
	Derate above 25°C	2.8	1.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

P-Channel Switch

(continued)

Electrical Characteristics

TA = 25°C unless otherwise noted

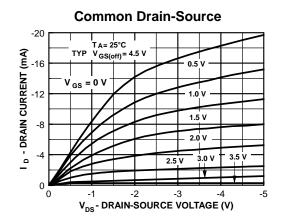
Symbol	Parameter	lest Conditions		Min	Max	Units
055 0114	DAOTEDIOTIOO					
OFF CHA	RACTERISTICS	_				
$B_{(BR)GSS}$	Gate-Source Breakdown Voltage	$I_G = 1.0 \mu A, V_{DS} = 0$		30		V
I _{GSS}	Gate Reverse Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0$			1.0	nA
V _{GS(off)}	Gate-Source Cutoff Voltage	$V_{DS} = -15 \text{ V}, I_{D} = -10 \text{ nA}$	J174	5.0	10	V
			J175	3.0	6.0	V
			J176	1.0	4.0	V
			J177	0.8	2.5	V

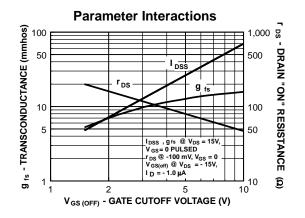
ON CHARACTERISTICS

I _{DSS}	Zero-Gate Voltage Drain Current*	$V_{DS} = -15 \text{ V}, I_{GS} = 0$	J174	- 20	- 100	mA
			J175	- 7.0	- 60	mA
			J176	- 2.0	- 25	mA
			J177	- 1.5	- 20	mA
r _{DS(on)}	Drain-Source On Resistance	$V_{DS} \le 0.1 \text{ V}, V_{GS} = 0$	J174		85	Ω
(,			J175		125	Ω
			J176		250	Ω
			J177		300	Ω

^{*}Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2.0\%$

Typical Characteristics

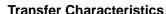


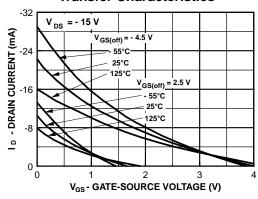


P-Channel Switch

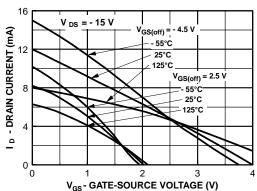
(continued)

Typical Characteristics (continued)

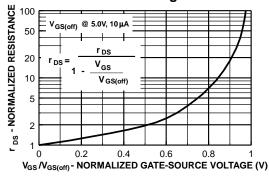




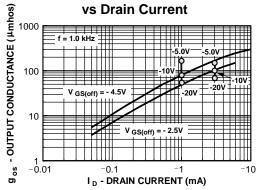
Transfer Characteristics



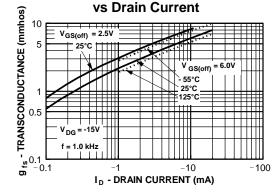
Normalized Drain Resistance vs Bias Voltage



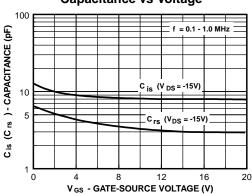
Output Conductance



Transconductance



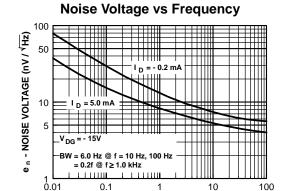
Capacitance vs Voltage



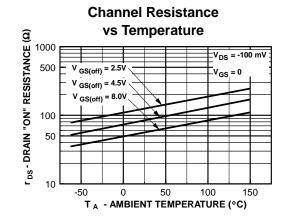
P-Channel Switch

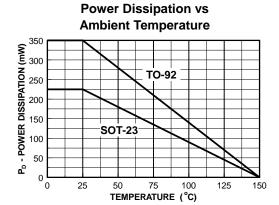
(continued)

Typical Characteristics (continued)



f - FREQUENCY (kHz)





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